

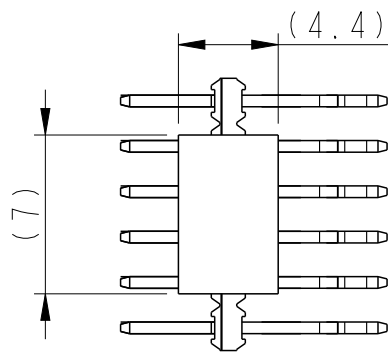
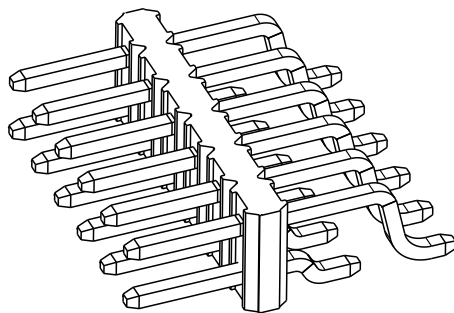


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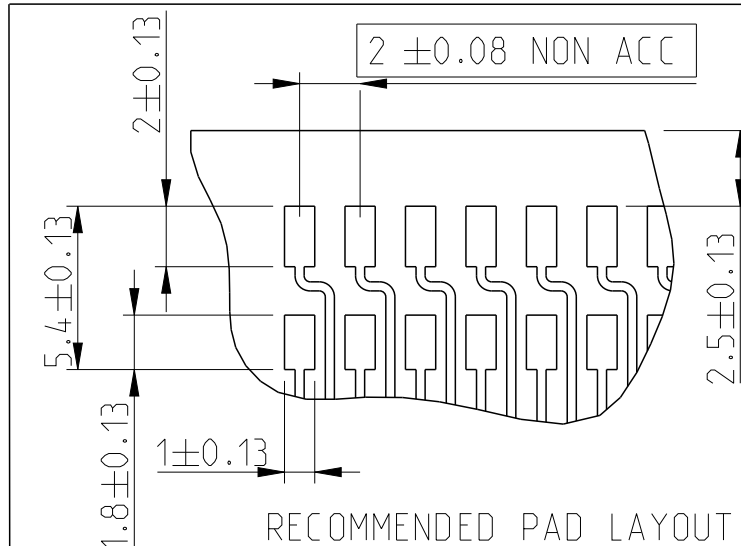
C

D

- NOTES :
- 1- MATERIALS :
BODY : High Temp thermoplastic 30% GF, COLOR BLACK UL94 V-0
PIN : COPPER ALLOY
- 2- 7N MIN PIN RETENTION IN EITHER DIRECTION
- 3- RoHS COMPATIBLE PRODUCT SPECIFICATION :
a- PLATING : LF means the product is Lead Free,
2µ MIN matte Tin over 1.27µ Nickel underplating.
b- MANUFACTURING PRODUCT SPECIFICATION :
Housing will withstand exposure to 260°C peak temperature
for 30 secondes in a convection infra-red or vapor phase oven.
c- LABELLING :
Meets packaging specs as per GS-14-920
d- LEGAL STATMENT : See GS-47-0004
- 4- PLANE REFERENCE -A- IS GENERATED BY LONG PINS TAIL ROW
WITH LOWEST AREA OF BODY.
SHORT PINS ROW TO BE FLUSH OR HIGHER 0.1 MAX ABOVE REF -A-.
- 5- MINIMUM QUANTITY IN BLI BOX : 500

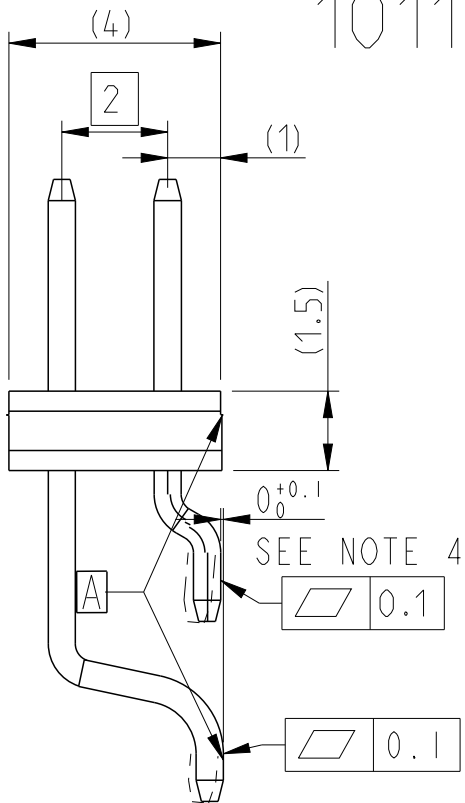
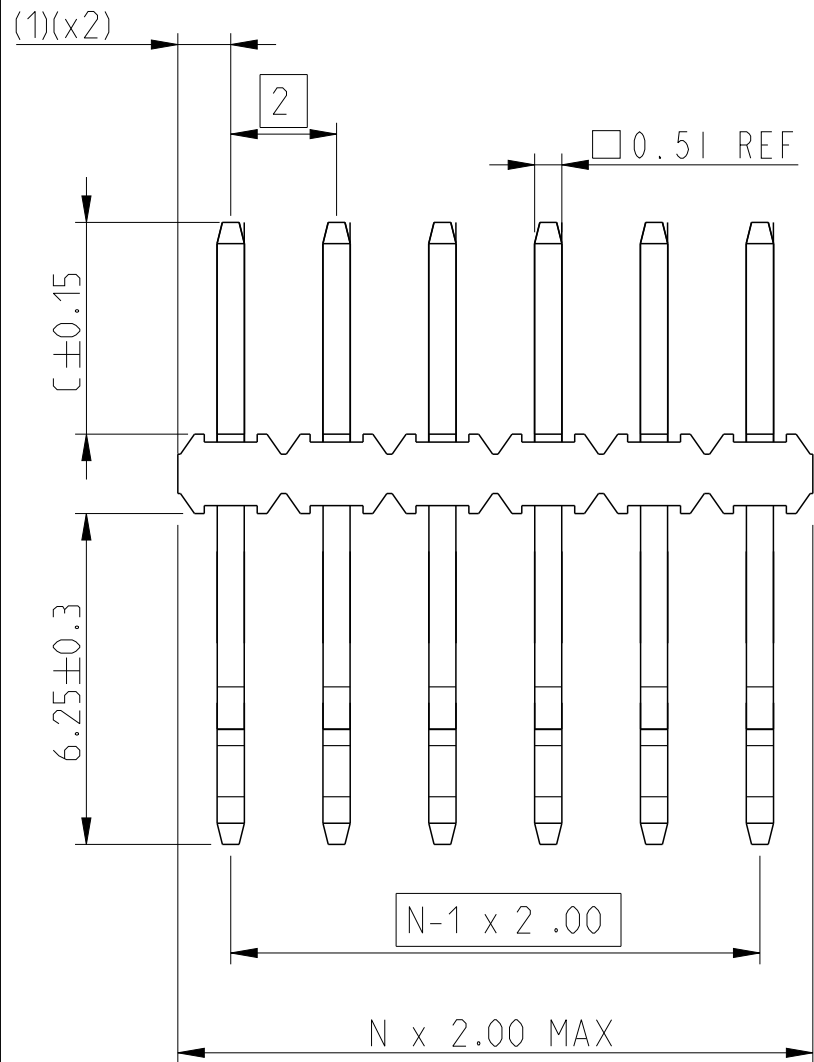


SCALE 3:1
VIEW WITH
PICK-UP CAP



RECOMMENDED PAD LAYOUT

spec ref		GS-12-652		dr		A Parrenin		2014/02/28		projection		mm		size		A3		scale		4:1			
tolerance std		TOLERANCES UNLESS OTHERWISE SPECIFIED		eng		A Parrenin		2014/03/19						ecn no		ELX-B-17245-1							
ISO 406				chr		D Convercey		2014/03/20															
ISO 1101				appr		Gert Droesbeke		2014/03/21						product family						rel level			
surface		linear		0.X		±0.30				title		HEADER UNSHROUDED SMT		dwg no		10112690C		rev		E			
				0.XX		±0.13																	
				0.XXX		±0.05																	
ISO 1302		angular		0°		±1°		www.fci.com		cat. no.		-		Product - Customer Drw		sheet 1 of 1							



10112690 - X XX-YY Z LF

INDICATES THAT PRODUCT
IS RoHS COMPATIBLE SEE NOTE 3

PACKAGING :

A = Tape and reel with Pick-up cap
See GS-14-1516 As available
U = Tube without Pick-up cap. Only
for rows contacts qty from 4 to 25
See GS-14-1551

Blank = Bli box for rows contacts qty
2 and 3 see note 5

NBR CONTACTS PER ROW : 02 TO 25 = N

STYLE	01	02	03	04	05
DIM C POST LENGTH	3.2	2.0	4.0	7.0	5.84

PLATING : G= 0.76µ Gold/GXT on mating area
2-6µ Pure Tin on solder area
F= Gold flash on mating area
2-6µ pure Tin on solder area
T= 2-6µ pure Tin on mating area
2-6µ pure Tin on solder area
All with 1.27 Ni underplating